

NOVA™ Automated & Multi-Configurable Polishing System

PRECISION OPTICAL POLISHING

TABLET CONTROL WITH MICROFEED™

SUPPORTS ALL INDUSTRY STANDARD AND CONNECTORS / MIL-TERMINI / FERRULES

AIR POLISHING IN MACHINE

TELCORDIA COMPLIANT

INTERCHANGEABLE FIXTURES FOR WAVEGUIDES, BARE FIBERS AND MORE



Maximum flexibility for optical surface processing is now available with NOVA[™]. KrellTech has integrated the proven performance and features of its industry leading Scepter, Trig and FLex polishers into this configurable and cost-effective system.

NOVA[™] supports a variety of polishing applications from connectors to waveguides, and bare fibers to custom components. NOVA[™] is scalable for R&D projects, high volume production, and the rigors of harsh environments and field installation.



NOVA™ workholders feature patented independent KrellTech's suspension at each connector position for controlled pressure and uniform contact. Combined with NOVA's Microfeed™ fixture advancement, "airconnector polishing" and epoxy removal can be performed directly in the machine.

Each position is optically aligned for optimal polish geometry using KrellTech's patented process and calibration mechanism. Connector types can also be mixed and matched in a single fixture. NOVA's versatility provides the ability to support the polishing of many photonic components. A quick change-out of workholder fixtures provides processing capability for waveguides, optical chips, PLCs, lenses and fiber arrays.

Workholders utilize a unique holding mechanism that can secure a wide range of component dimensions. The polishing angle is adjustable and custom fixtures can be fabricated for specialized applications. Bare fiber can be polished at variable angles using specialized workholders and adapters.=

A variety of fiber types from standard singlemode to PM, and sapphire to PCF can be processed into wedge and chisel tip shapes.

A quick swap-out of adapters allow the polishing of fiber diameters from 80um to >3mm. Optional video inspection systems monitor the polishing process and inspect the polished surface directly in NOVA.

SPECIFICATIONS AND FEATURES

*	16% 🗎 5:43 PM		🕸 16% 🗐 5:44 PM
← Edit Program CANCEL	SAVE 🏌	← Edit Step	CANCEL SAVE 🔆
Program Name 2.5mm UPC Polish	16/16	Process Name Air	Polish
Program Description ST/FC/SC UPC New Termination Process	10710	Instructions Ora	ange Pad with 3um SiC Film - Dry 35/75
Workholder Name / Instructions 2.5mm UPC		Pad Color Or	ange 🚽 🔴
Steps	ADD STEP	MicroFeed Routine?	•
■ Orange Pad with 3um SiC Film - Dry	/ 1	Start Position (0 - 50 mm	40.0
■ Fine Diamond Polish	/ 1	MicroFeed Rate (revs / se	c) <u>0.5</u>
Final Polish	/ 1	Stop Position (0 - 50 mm) Platen Speed (revs / sec)	46.0 7 3.0 7

NOVA[™] features an intuitive user interface for creating polishing programs. All parameters including cycle time, pressure and speed settings are easily inputted for all component types and desired surface geometries.

A unique "manual mode" allows the adjustment of polishing parameters in real-time during NOVA[™] operation. This feature streamlines process development efforts and facilitates easy and quick program creation and refinement.

Connector Performance

Connector Support²

All industry standard connectors Mil-spec termini and ferrules UPC & APC geometries

Capacity

Up to 8 components. Selections be mixed & matched in same workholder fixture.

Apex Offset

<50 microns, maximum <15 microns, typical

Radius of Curvature 10-25 mm, 2.5 mm ferrules 7-20 mm, 1.25 mm ferrules 5-12 mm, APC ferrules Protrusion/Undercut³

50nm to -120 n Back Reflection⁴ < -60 dB, UPC

< -65 dB, APC Insertion Loss⁴

< 0.25 dB, typical **Process Time**⁵

Approximately 15 sec/connector

² Polishing performance meets and exceeds Telcordia/IEC. specifications, and can be optimized for specific applications. ³ Oppendent upon radius of curvature. ⁴ Optical performance may vary between connector

manufacturers ⁵ Singlemode UPC/APC finish.

Waveguide Performance

Component Support Waveguides, planar lightwave circuits, optical chips, fiber arrays Component Dimension Range⁶ Width: 5mm to 30mm Thickness: 0.5mm to 5mm Length: >5mm Angle Repeatability +/-0.3 degrees (X/Y axis along edge) Adjustable Polish Angle Range⁶ 0 deg. (flat) to 45 degrees

6 Custom dimensions and angles available



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Operational

Controller¹

Wireless tablet with Android operating system

Polishing Pressure

Programmable & automated. Linear displacement with micron positioning control.

Polishing Speed

Program selectable

Cycling Timing Program selectable

Polishing Motion

Random orbital

Polishing Routines

(1) Programmable, step by step prompts

(2) Microfeed[™] controlled advancement

(3) Manual mode with full process control

Film Size

4 inch diameter.

Equipment Footprint & Weight

12" x 12" (305 x 305mm) 25lbs

¹Wired version available

Bare Fiber Performance

Fiber Types

Singlemode, multimode, PM, plastic, PCF, chalcogenide, sapphire and specialty fibers

Fiber Diameter 80um to >3mm Angle Range⁷ 0 deg. (flat) to 50 degrees

Angle Repeatability

± 0.5 degrees, typical

⁷ Referenced off fiber diameter (i.e. 8° for APC style connector polish). Custom angles available.

Inspection Options

Real-Time Polishing Inspection 80x Magnification In-Line Surface Inspection 400x Magnification (standard) Coaxial Illumination Video Signal EIA/NTSC Compatible Switchable Source Geometry Measurements Software for angle, length and point-to-point measurements.

Specifications subject to change without notice Rev.1, 4/17

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